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Applications of "[Embedded - Microcontrollers](#)"

Details

Product Status	Active
Core Processor	RXv2
Core Size	32-Bit Single-Core
Speed	54MHz
Connectivity	CANbus, EBI/EMI, I ² C, IrDA, SCI, SD/SDIO, SPI, SSI, USB OTG
Peripherals	DMA, LVD, POR, PWM, WDT
Number of I/O	79
Program Memory Size	512KB (512K x 8)
Program Memory Type	FLASH
EEPROM Size	8K x 8
RAM Size	64K x 8
Voltage - Supply (Vcc/Vdd)	1.8V ~ 5.5V
Data Converters	A/D 24x12b; D/A 2x12b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	100-LQFP
Supplier Device Package	100-LFQFP (14x14)
Purchase URL	https://www.e-xfl.com/product-detail/renesas-electronics-america/r5f52318adfp-30

1.5 Pin Assignments

Figure 1.3 to Figure 1.9 show the pin assignments. Table 1.6 to Table 1.10 show the lists of pins and pin functions.

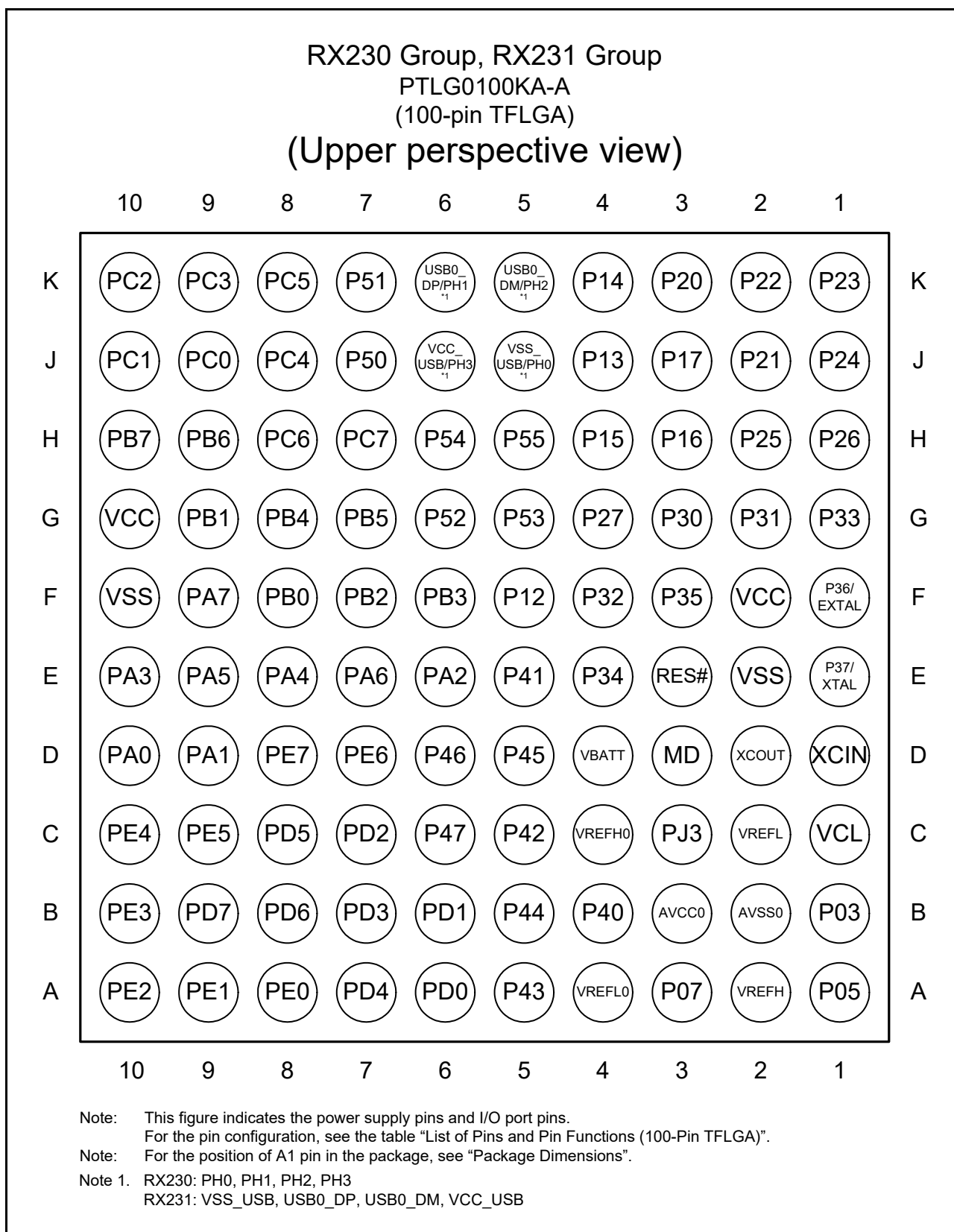


Figure 1.3 Pin Assignments of the 100-Pin TFLGA (Upper Perspective View)

Table 1.7 List of Pins and Pin Functions (100-Pin LFQFP) (3/3)

Pin No.	Power Supply, Clock, System Control	I/O Port	External Bus	Timers (MTU, TPU, TMR, RTC, CMT, POE, CAC)	Communications (SCI, RSPI, RIIIC, RSCAN, USB, SSI)	Memory Interface (SDHI)	Touch sensing	Others
79		PD7	D7[A7/D7]	MTIC5U/POE0#				IRQ7/AN031
80		PD6	D6[A6/D6]	MTIC5V/POE1#				IRQ6/AN030
81		PD5	D5[A5/D5]	MTIC5W/POE2#				IRQ5/AN029
82		PD4	D4[A4/D4]	POE3#				IRQ4/AN028
83		PD3	D3[A3/D3]	POE8#				IRQ3/AN027
84		PD2	D2[A2/D2]	MTIOC4D				IRQ2/AN026
85		PD1	D1[A1/D1]	MTIOC4B				IRQ1/AN025
86		PD0	D0[A0/D0]					IRQ0/AN024
87		P47						AN007
88		P46						AN006
89		P45						AN005
90		P44						AN004
91		P43						AN003
92		P42						AN002
93		P41						AN001
94	VREFL0							
95		P40						AN000
96	VREFH0							
97	AVCC0							
98		P07						ADTRG0#
99	AVSS0							
100		P05						DA1

Note 1. RX230: PH0/CACREF, PH1/IRQ0/TMO0, PH2/IRQ1/TMRI0, PH3/TMCI0
 RX231: VSS_USB, USB0_DP, USB0_DM, VCC_USB

Table 4.1 List of I/O Registers (Address Order) (15/33)

Address	Module Symbol	Register Name	Register Symbol	Number of Bits	Access Size	Number of Access Cycles	
						ICLK $\geq$ PCLK	ICLK < PCLK
0008 B305h	SCI12	Receive Data Register	RDR	8	8	2 or 3 PCLKB	2 ICLK
0008 B306h	SCI12	Smart Card Mode Register	SCMR	8	8	2 or 3 PCLKB	2 ICLK
0008 B307h	SCI12	Serial Extended Mode Register	SEMR	8	8	2 or 3 PCLKB	2 ICLK
0008 B308h	SCI12	Noise Filter Setting Register	SNFR	8	8	2 or 3 PCLKB	2 ICLK
0008 B309h	SCI12	I ² C Mode Register 1	SIMR1	8	8	2 or 3 PCLKB	2 ICLK
0008 B30Ah	SCI12	I ² C Mode Register 2	SIMR2	8	8	2 or 3 PCLKB	2 ICLK
0008 B30Bh	SCI12	I ² C Mode Register 3	SIMR3	8	8	2 or 3 PCLKB	2 ICLK
0008 B30Ch	SCI12	I ² C Status Register	SISR	8	8	2 or 3 PCLKB	2 ICLK
0008 B30Dh	SCI12	SPI Mode Register	SPMR	8	8	2 or 3 PCLKB	2 ICLK
0008 B30Eh	SCI12	Transmit Data Register HL	TDRHL	16	16	4 or 5 PCLKB	2 ICLK
0008 B30Eh	SCI12	Transmit Data Register H	TDRH	8	8	2 or 3 PCLKB	2 ICLK
0008 B30Fh	SCI12	Transmit Data Register L	TDRL	8	8	2 or 3 PCLKB	2 ICLK
0008 B310h	SCI12	Receive Data Register HL	RDRHL	16	16	4 or 5 PCLKB	2 ICLK
0008 B310h	SCI12	Receive Data Register H	RDRH	8	8	2 or 3 PCLKB	2 ICLK
0008 B311h	SCI12	Receive Data Register L	RDRL	8	8	2 or 3 PCLKB	2 ICLK
0008 B312h	SCI12	Modulation Duty Register	MDDR	8	8	2 or 3 PCLKB	2 ICLK
0008 B320h	SCI12	Extended Serial Module Enable Register	ESMER	8	8	2 or 3 PCLKB	2 ICLK
0008 B321h	SCI12	Control Register 0	CR0	8	8	2 or 3 PCLKB	2 ICLK
0008 B322h	SCI12	Control Register 1	CR1	8	8	2 or 3 PCLKB	2 ICLK
0008 B323h	SCI12	Control Register 2	CR2	8	8	2 or 3 PCLKB	2 ICLK
0008 B324h	SCI12	Control Register 3	CR3	8	8	2 or 3 PCLKB	2 ICLK
0008 B325h	SCI12	Port Control Register	PCR	8	8	2 or 3 PCLKB	2 ICLK
0008 B326h	SCI12	Interrupt Control Register	ICR	8	8	2 or 3 PCLKB	2 ICLK
0008 B327h	SCI12	Status Register	STR	8	8	2 or 3 PCLKB	2 ICLK
0008 B328h	SCI12	Status Clear Register	STCR	8	8	2 or 3 PCLKB	2 ICLK
0008 B329h	SCI12	Control Field 0 Data Register	CF0DR	8	8	2 or 3 PCLKB	2 ICLK
0008 B32Ah	SCI12	Control Field 0 Compare Enable Register	CF0CR	8	8	2 or 3 PCLKB	2 ICLK
0008 B32Bh	SCI12	Control Field 0 Receive Data Register	CF0RR	8	8	2 or 3 PCLKB	2 ICLK
0008 B32Ch	SCI12	Primary Control Field 1 Data Register	PCF1DR	8	8	2 or 3 PCLKB	2 ICLK
0008 B32Dh	SCI12	Secondary Control Field 1 Data Register	SCF1DR	8	8	2 or 3 PCLKB	2 ICLK
0008 B32Eh	SCI12	Control Field 1 Compare Enable Register	CF1CR	8	8	2 or 3 PCLKB	2 ICLK
0008 B32Fh	SCI12	Control Field 1 Receive Data Register	CF1RR	8	8	2 or 3 PCLKB	2 ICLK
0008 B330h	SCI12	Timer Control Register	TCR	8	8	2 or 3 PCLKB	2 ICLK
0008 B331h	SCI12	Timer Mode Register	TMR	8	8	2 or 3 PCLKB	2 ICLK
0008 B332h	SCI12	Timer Prescaler Register	TPRE	8	8	2 or 3 PCLKB	2 ICLK
0008 B333h	SCI12	Timer Count Register	TCNT	8	8	2 or 3 PCLKB	2 ICLK
0008 C000h	PORT0	Port Direction Register	PDR	8	8	2 or 3 PCLKB	2 ICLK
0008 C001h	PORT1	Port Direction Register	PDR	8	8	2 or 3 PCLKB	2 ICLK
0008 C002h	PORT2	Port Direction Register	PDR	8	8	2 or 3 PCLKB	2 ICLK
0008 C003h	PORT3	Port Direction Register	PDR	8	8	2 or 3 PCLKB	2 ICLK
0008 C004h	PORT4	Port Direction Register	PDR	8	8	2 or 3 PCLKB	2 ICLK
0008 C005h	PORT5	Port Direction Register	PDR	8	8	2 or 3 PCLKB	2 ICLK
0008 C00Ah	PORTA	Port Direction Register	PDR	8	8	2 or 3 PCLKB	2 ICLK
0008 C00Bh	PORTB	Port Direction Register	PDR	8	8	2 or 3 PCLKB	2 ICLK
0008 C00Ch	PORTC	Port Direction Register	PDR	8	8	2 or 3 PCLKB	2 ICLK
0008 C00Dh	PORTD	Port Direction Register	PDR	8	8	2 or 3 PCLKB	2 ICLK
0008 C00Eh	PORTE	Port Direction Register	PDR	8	8	2 or 3 PCLKB	2 ICLK
0008 C011h	PORTH	Port Direction Register	PDR	8	8	2 or 3 PCLKB	2 ICLK
0008 C012h	PORTJ	Port Direction Register	PDR	8	8	2 or 3 PCLKB	2 ICLK
0008 C020h	PORT0	Port Output Data Register	PODR	8	8	2 or 3 PCLKB	2 ICLK
0008 C021h	PORT1	Port Output Data Register	PODR	8	8	2 or 3 PCLKB	2 ICLK
0008 C022h	PORT2	Port Output Data Register	PODR	8	8	2 or 3 PCLKB	2 ICLK

Table 4.1 List of I/O Registers (Address Order) (25/33)

Address	Module Symbol	Register Name	Register Symbol	Number of Bits	Access Size	Number of Access Cycles	
						ICLK ≥ PCLK	ICLK < PCLK
000A 83AAh	RSCAN	Receive Rule Entry Register 0CH	GAFLPH0	16	16	2 or 3 PCLKB	2 ICLK
000A 83AAh	RSCAN	Receive Buffer Register 0CH	RMDF10	16	16	2 or 3 PCLKB	2 ICLK
000A 83ACh	RSCAN	Receive Rule Entry Register 1AL	GAFLIDL1	16	16	2 or 3 PCLKB	2 ICLK
000A 83ACh	RSCAN	Receive Buffer Register 0DL	RMDF20	16	16	2 or 3 PCLKB	2 ICLK
000A 83AEh	RSCAN	Receive Rule Entry Register 1AH	GAFLIDH1	16	16	2 or 3 PCLKB	2 ICLK
000A 83AEh	RSCAN	Receive Buffer Register 0DH	RMDF30	16	16	2 or 3 PCLKB	2 ICLK
000A 83B0h	RSCAN	Receive Rule Entry Register 1BL	GAFLML1	16	16	2 or 3 PCLKB	2 ICLK
000A 83B0h	RSCAN	Receive Buffer Register 1AL	RMIDL1	16	16	2 or 3 PCLKB	2 ICLK
000A 83B2h	RSCAN	Receive Rule Entry Register 1BH	GAFLMH1	16	16	2 or 3 PCLKB	2 ICLK
000A 83B2h	RSCAN	Receive Buffer Register 1AH	RMIDH1	16	16	2 or 3 PCLKB	2 ICLK
000A 83B4h	RSCAN	Receive Rule Entry Register 1CL	GAFLPL1	16	16	2 or 3 PCLKB	2 ICLK
000A 83B4h	RSCAN	Receive Buffer Register 1BL	RMTS1	16	16	2 or 3 PCLKB	2 ICLK
000A 83B6h	RSCAN	Receive Rule Entry Register 1CH	GAFLPH1	16	16	2 or 3 PCLKB	2 ICLK
000A 83B6h	RSCAN	Receive Buffer Register 1BH	RMPTR1	16	16	2 or 3 PCLKB	2 ICLK
000A 83B8h	RSCAN	Receive Rule Entry Register 2AL	GAFLIDL2	16	16	2 or 3 PCLKB	2 ICLK
000A 83B8h	RSCAN	Receive Buffer Register 1CL	RMDF01	16	16	2 or 3 PCLKB	2 ICLK
000A 83BAh	RSCAN	Receive Rule Entry Register 2AH	GAFLIDH2	16	16	2 or 3 PCLKB	2 ICLK
000A 83BAh	RSCAN	Receive Buffer Register 1CH	RMDF11	16	16	2 or 3 PCLKB	2 ICLK
000A 83BCh	RSCAN	Receive Rule Entry Register 2BL	GAFLML2	16	16	2 or 3 PCLKB	2 ICLK
000A 83BCh	RSCAN	Receive Buffer Register 1DL	RMDF21	16	16	2 or 3 PCLKB	2 ICLK
000A 83BEh	RSCAN	Receive Rule Entry Register 2BH	GAFLMH2	16	16	2 or 3 PCLKB	2 ICLK
000A 83BEh	RSCAN	Receive Buffer Register 1DH	RMDF31	16	16	2 or 3 PCLKB	2 ICLK
000A 83C0h	RSCAN	Receive Rule Entry Register 2CL	GAFLPL2	16	16	2 or 3 PCLKB	2 ICLK
000A 83C0h	RSCAN	Receive Buffer Register 2AL	RMIDL2	16	16	2 or 3 PCLKB	2 ICLK
000A 83C2h	RSCAN	Receive Rule Entry Register 2CH	GAFLPH2	16	16	2 or 3 PCLKB	2 ICLK
000A 83C2h	RSCAN	Receive Buffer Register 2AH	RMIDH2	16	16	2 or 3 PCLKB	2 ICLK
000A 83C4h	RSCAN	Receive Rule Entry Register 3AL	GAFLIDL3	16	16	2 or 3 PCLKB	2 ICLK
000A 83C4h	RSCAN	Receive Buffer Register 2BL	RMTS2	16	16	2 or 3 PCLKB	2 ICLK
000A 83C6h	RSCAN	Receive Rule Entry Register 3AH	GAFLIDH3	16	16	2 or 3 PCLKB	2 ICLK
000A 83C6h	RSCAN	Receive Buffer Register 2BH	RMPTR2	16	16	2 or 3 PCLKB	2 ICLK
000A 83C8h	RSCAN	Receive Rule Entry Register 3BL	GAFLML3	16	16	2 or 3 PCLKB	2 ICLK
000A 83C8h	RSCAN	Receive Buffer Register 2CL	RMDF02	16	16	2 or 3 PCLKB	2 ICLK
000A 83CAh	RSCAN	Receive Rule Entry Register 3BH	GAFLMH3	16	16	2 or 3 PCLKB	2 ICLK
000A 83CAh	RSCAN	Receive Buffer Register 2CH	RMDF12	16	16	2 or 3 PCLKB	2 ICLK
000A 83CCh	RSCAN	Receive Rule Entry Register 3CL	GAFLPL3	16	16	2 or 3 PCLKB	2 ICLK
000A 83CCh	RSCAN	Receive Buffer Register 2DL	RMDF22	16	16	2 or 3 PCLKB	2 ICLK
000A 83CEh	RSCAN	Receive Rule Entry Register 3CH	GAFLPH3	16	16	2 or 3 PCLKB	2 ICLK
000A 83CEh	RSCAN	Receive Buffer Register 2DH	RMDF32	16	16	2 or 3 PCLKB	2 ICLK
000A 83D0h	RSCAN	Receive Rule Entry Register 4AL	GAFLIDL4	16	16	2 or 3 PCLKB	2 ICLK
000A 83D0h	RSCAN	Receive Buffer Register 3AL	RMIDL3	16	16	2 or 3 PCLKB	2 ICLK
000A 83D2h	RSCAN	Receive Rule Entry Register 4AH	GAFLIDH4	16	16	2 or 3 PCLKB	2 ICLK
000A 83D2h	RSCAN	Receive Buffer Register 3AH	RMIDH3	16	16	2 or 3 PCLKB	2 ICLK
000A 83D4h	RSCAN	Receive Rule Entry Register 4BL	GAFLML4	16	16	2 or 3 PCLKB	2 ICLK
000A 83D4h	RSCAN	Receive Buffer Register 3BL	RMTS3	16	16	2 or 3 PCLKB	2 ICLK
000A 83D6h	RSCAN	Receive Rule Entry Register 4BH	GAFLMH4	16	16	2 or 3 PCLKB	2 ICLK
000A 83D6h	RSCAN	Receive Buffer Register 3BH	RMPTR3	16	16	2 or 3 PCLKB	2 ICLK
000A 83D8h	RSCAN	Receive Rule Entry Register 4CL	GAFLPL4	16	16	2 or 3 PCLKB	2 ICLK
000A 83D8h	RSCAN	Receive Buffer Register 3CL	RMDF03	16	16	2 or 3 PCLKB	2 ICLK
000A 83DAh	RSCAN	Receive Rule Entry Register 4CH	GAFLPH4	16	16	2 or 3 PCLKB	2 ICLK
000A 83DAh	RSCAN	Receive Buffer Register 3CH	RMDF13	16	16	2 or 3 PCLKB	2 ICLK
000A 83DCh	RSCAN	Receive Rule Entry Register 5AL	GAFLIDL5	16	16	2 or 3 PCLKB	2 ICLK
000A 83DCh	RSCAN	Receive Buffer Register 3DL	RMDF23	16	16	2 or 3 PCLKB	2 ICLK

Table 4.1 List of I/O Registers (Address Order) (32/33)

Address	Module Symbol	Register Name	Register Symbol	Number of Bits	Access Size	Number of Access Cycles	
						ICLK $\geq$ PCLK	ICLK < PCLK
000D 0A34h	MTU	Timer Dead Time Enable Register	TDER	8	8	2 or 3 PCLKA	2 ICLK
000D 0A36h	MTU	Timer Output Level Buffer Register	TOLBR	8	8	2 or 3 PCLKA	2 ICLK
000D 0A38h	MTU3	Timer Buffer Operation Transfer Mode Register	TBTM	8	8	2 or 3 PCLKA	2 ICLK
000D 0A39h	MTU4	Timer Buffer Operation Transfer Mode Register	TBTM	8	8	2 or 3 PCLKA	2 ICLK
000D 0A40h	MTU4	Timer A/D Converter Start Request Control Register	TADCR	16	16	2 or 3 PCLKA	2 ICLK
000D 0A44h	MTU4	Timer A/D Converter Start Request Cycle Set Register A	TADCORA	16	16	2 or 3 PCLKA	2 ICLK
000D 0A46h	MTU4	Timer A/D Converter Start Request Cycle Set Register B	TADCORB	16	16	2 or 3 PCLKA	2 ICLK
000D 0A48h	MTU4	Timer A/D Converter Start Request Cycle Set Buffer Register A	TADCOBRA	16	16	2 or 3 PCLKA	2 ICLK
000D 0A4Ah	MTU4	Timer A/D Converter Start Request Cycle Set Buffer Register B	TADCOBRB	16	16	2 or 3 PCLKA	2 ICLK
000D 0A60h	MTU	Timer Waveform Control Register	TWCR	8	8, 16	2 or 3 PCLKA	2 ICLK
000D 0A80h	MTU	Timer Start Register	TSTR	8	8, 16	2 or 3 PCLKA	2 ICLK
000D 0A81h	MTU	Timer Synchronous Register	TSYR	8	8, 16	2 or 3 PCLKA	2 ICLK
000D 0A84h	MTU	Timer Read/Write Enable Register	TRWER	8	8, 16	2 or 3 PCLKA	2 ICLK
000D 0A90h	MTU0	Noise Filter Control Register	NFCR	8	8, 16	2 or 3 PCLKA	2 ICLK
000D 0A91h	MTU1	Noise Filter Control Register	NFCR	8	8, 16	2 or 3 PCLKA	2 ICLK
000D 0A92h	MTU2	Noise Filter Control Register	NFCR	8	8, 16	2 or 3 PCLKA	2 ICLK
000D 0A93h	MTU3	Noise Filter Control Register	NFCR	8	8, 16	2 or 3 PCLKA	2 ICLK
000D 0A94h	MTU4	Noise Filter Control Register	NFCR	8	8, 16	2 or 3 PCLKA	2 ICLK
000D 0A95h	MTU5	Noise Filter Control Register	NFCR	8	8, 16	2 or 3 PCLKA	2 ICLK
000D 0B00h	MTU0	Timer Control Register	TCR	8	8	2 or 3 PCLKA	2 ICLK
000D 0B01h	MTU0	Timer Mode Register	TMDR	8	8	2 or 3 PCLKA	2 ICLK
000D 0B02h	MTU0	Timer I/O Control Register H	TIORH	8	8	2 or 3 PCLKA	2 ICLK
000D 0B03h	MTU0	Timer I/O Control Register L	TIORL	8	8	2 or 3 PCLKA	2 ICLK
000D 0B04h	MTU0	Timer Interrupt Enable Register	TIER	8	8	2 or 3 PCLKA	2 ICLK
000D 0B05h	MTU0	Timer Status Register	TSR	8	8	2 or 3 PCLKA	2 ICLK
000D 0B06h	MTU0	Timer Counter	TCNT	16	16	2 or 3 PCLKA	2 ICLK
000D 0B08h	MTU0	Timer General Register A	TGRA	16	16	2 or 3 PCLKA	2 ICLK
000D 0B0Ah	MTU0	Timer General Register B	TGRB	16	16	2 or 3 PCLKA	2 ICLK
000D 0B0Ch	MTU0	Timer General Register C	TGRC	16	16	2 or 3 PCLKA	2 ICLK
000D 0B0Eh	MTU0	Timer General Register D	TGRD	16	16	2 or 3 PCLKA	2 ICLK
000D 0B20h	MTU0	Timer General Register E	TGRE	16	16	2 or 3 PCLKA	2 ICLK
000D 0B22h	MTU0	Timer General Register F	TGRF	16	16	2 or 3 PCLKA	2 ICLK
000D 0B24h	MTU0	Timer Interrupt Enable Register 2	TIER2	8	8	2 or 3 PCLKA	2 ICLK
000D 0B26h	MTU0	Timer Buffer Operation Transfer Mode Register	TBTM	8	8	2 or 3 PCLKA	2 ICLK
000D 0B80h	MTU1	Timer Control Register	TCR	8	8	2 or 3 PCLKA	2 ICLK
000D 0B81h	MTU1	Timer Mode Register	TMDR	8	8	2 or 3 PCLKA	2 ICLK
000D 0B82h	MTU1	Timer I/O Control Register	TIOR	8	8	2 or 3 PCLKA	2 ICLK
000D 0B84h	MTU1	Timer Interrupt Enable Register	TIER	8	8	2 or 3 PCLKA	2 ICLK
000D 0B85h	MTU1	Timer Status Register	TSR	8	8	2 or 3 PCLKA	2 ICLK
000D 0B86h	MTU1	Timer Counter	TCNT	16	16	2 or 3 PCLKA	2 ICLK
000D 0B88h	MTU1	Timer General Register A	TGRA	16	16	2 or 3 PCLKA	2 ICLK
000D 0B8Ah	MTU1	Timer General Register B	TGRB	16	16	2 or 3 PCLKA	2 ICLK
000D 0B90h	MTU1	Timer Input Capture Control Register	TICCR	8	8	2 or 3 PCLKA	2 ICLK
000D 0C00h	MTU2	Timer Control Register	TCR	8	8	2 or 3 PCLKA	2 ICLK
000D 0C01h	MTU2	Timer Mode Register	TMDR	8	8	2 or 3 PCLKA	2 ICLK
000D 0C02h	MTU2	Timer I/O Control Register	TIOR	8	8	2 or 3 PCLKA	2 ICLK
000D 0C04h	MTU2	Timer Interrupt Enable Register	TIER	8	8	2 or 3 PCLKA	2 ICLK
000D 0C05h	MTU2	Timer Status Register	TSR	8	8	2 or 3 PCLKA	2 ICLK
000D 0C06h	MTU2	Timer Counter	TCNT	16	16	2 or 3 PCLKA	2 ICLK
000D 0C08h	MTU2	Timer General Register A	TGRA	16	16	2 or 3 PCLKA	2 ICLK
000D 0C0Ah	MTU2	Timer General Register B	TGRB	16	16	2 or 3 PCLKA	2 ICLK

Table 5.18 Output Values of Voltage (1)Conditions: $1.8\text{ V} \leq V_{CC} = V_{CC_USB} = AV_{CC0} < 2.7\text{ V}$, $V_{SS} = AV_{SS0} = V_{SS_USB} = 0\text{ V}$, $T_a = -40$ to $+105^\circ\text{C}$

Item				Symbol	Min.	Max.	Unit	Test Conditions
Output low	All output ports	Normal output mode		V _{OL}	—	0.3	V	I _{OL} = 0.5 mA
		High-drive output mode			—	0.3		I _{OL} = 1.0 mA
Output high	All output ports	Normal output mode	Ports 03, 05, 07, Ports 40 to 47	V _{OH}	AVCC0 – 0.3	—	V	I _{OH} = –0.5 mA
			Ports other than above		VCC – 0.3	—		
		High-drive output mode				VCC – 0.3		—

Table 5.19 Output Values of Voltage (2)Conditions: $2.7\text{ V} \leq V_{CC} = V_{CC_USB} = AV_{CC0} < 4.0\text{ V}$, $V_{SS} = AV_{SS0} = V_{SS_USB} = 0\text{ V}$, $T_a = -40$ to $+105^\circ\text{C}$

Item				Symbol	Min.	Max.	Unit	Test Conditions
Output low	All output ports (except for RIIC)	Normal output mode		V_{OL}	—	0.5	V	$I_{OL} = 1.0\text{ mA}$
		High-drive output mode			—	0.5		$I_{OL} = 2.0\text{ mA}$
	RIIC pins	Standard mode (Normal output mode)			—	0.4		$I_{OL} = 3.0\text{ mA}$
		Fast mode (High-drive output mode)			—	0.6		$I_{OL} = 6.0\text{ mA}$
Output high	All output ports	Normal output mode	Ports 03, 05, 07, Ports 40 to 47	V_{OH}	$AVCC0 - 0.5$	—	V	$I_{OH} = -1.0\text{ mA}$
			Ports other than above		$VCC - 0.5$			
		High-drive output mode			$VCC - 0.5$	—		$I_{OH} = -2.0\text{ mA}$

Table 5.20 Output Values of Voltage (3)Conditions: $4.0\text{ V} \leq V_{CC} = V_{CC_USB} = AV_{CC0} \leq 5.5\text{ V}$, $V_{SS} = AV_{SS0} = V_{SS_USB} = 0\text{ V}$, $T_a = -40$ to $+105^\circ\text{C}$

Item				Symbol	Min.	Max.	Unit	Test Conditions
Output low	All output ports (except for RIIC)	Normal output mode		V_{OL}	—	0.8	V	$I_{OL} = 2.0\text{ mA}$
		High-drive output mode			—	0.8		$I_{OL} = 4.0\text{ mA}$
	RIIC pins	Standard mode(Normal output mode)			—	0.4		$I_{OL} = 3.0\text{ mA}$
		Fast mode (High-drive output mode)			—	0.6		$I_{OL} = 6.0\text{ mA}$
Output high	All output ports	Normal output mode	Ports 03, 05, 07, Ports 40 to 47	V_{OH}	$AVCC0 - 0.8$	—	V	$I_{OH} = -2.0\text{ mA}$
			Ports other than above		$VCC - 0.8$	—		
		High-drive output mode			$VCC - 0.8$	—		$I_{OH} = -4.0\text{ mA}$

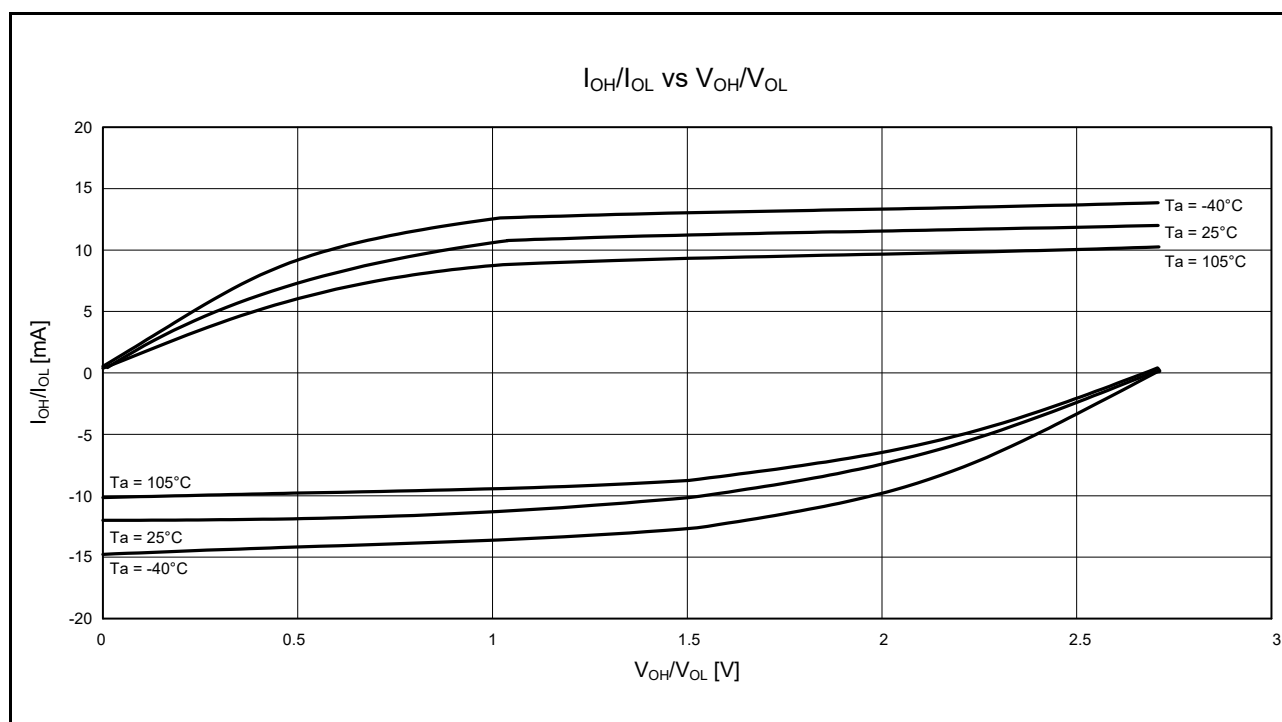


Figure 5.10 V_{OH}/V_{OL} and I_{OH}/I_{OL} Temperature Characteristics at $V_{CC} = 2.7$ V When Normal Output is Selected (Reference Data)

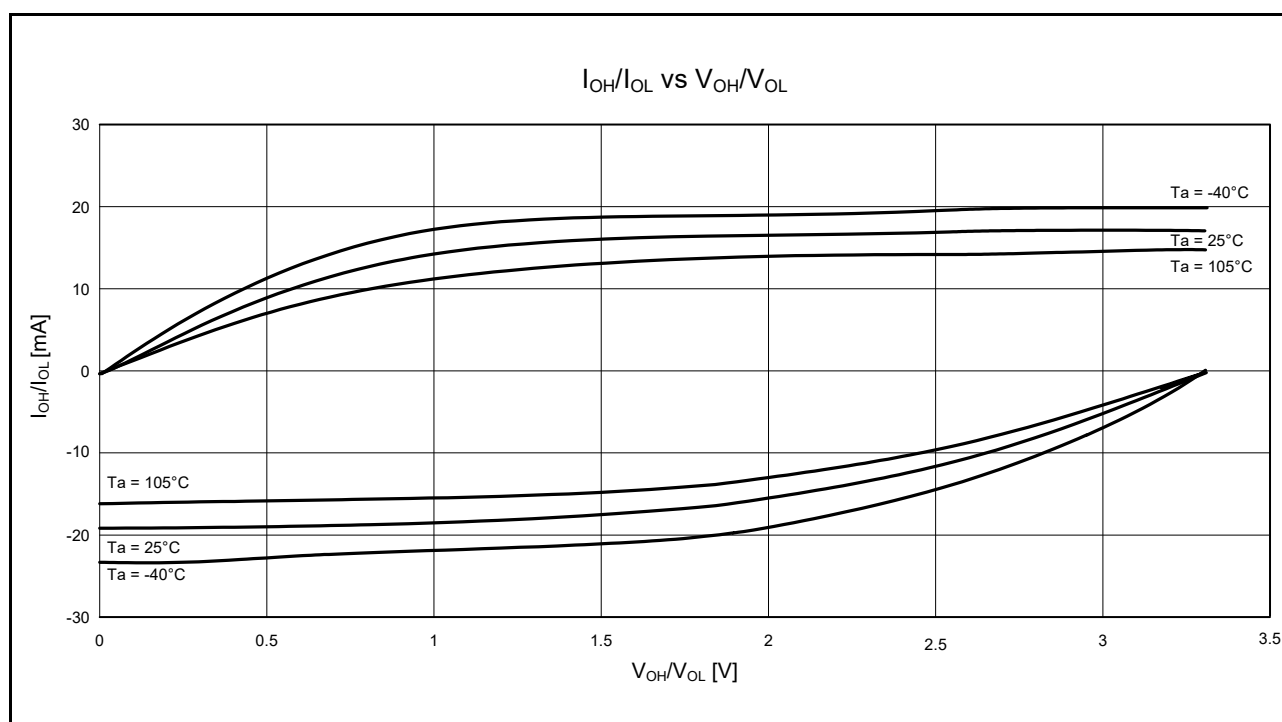


Figure 5.11 V_{OH}/V_{OL} and I_{OH}/I_{OL} Temperature Characteristics at $V_{CC} = 3.3$ V When Normal Output is Selected (Reference Data)

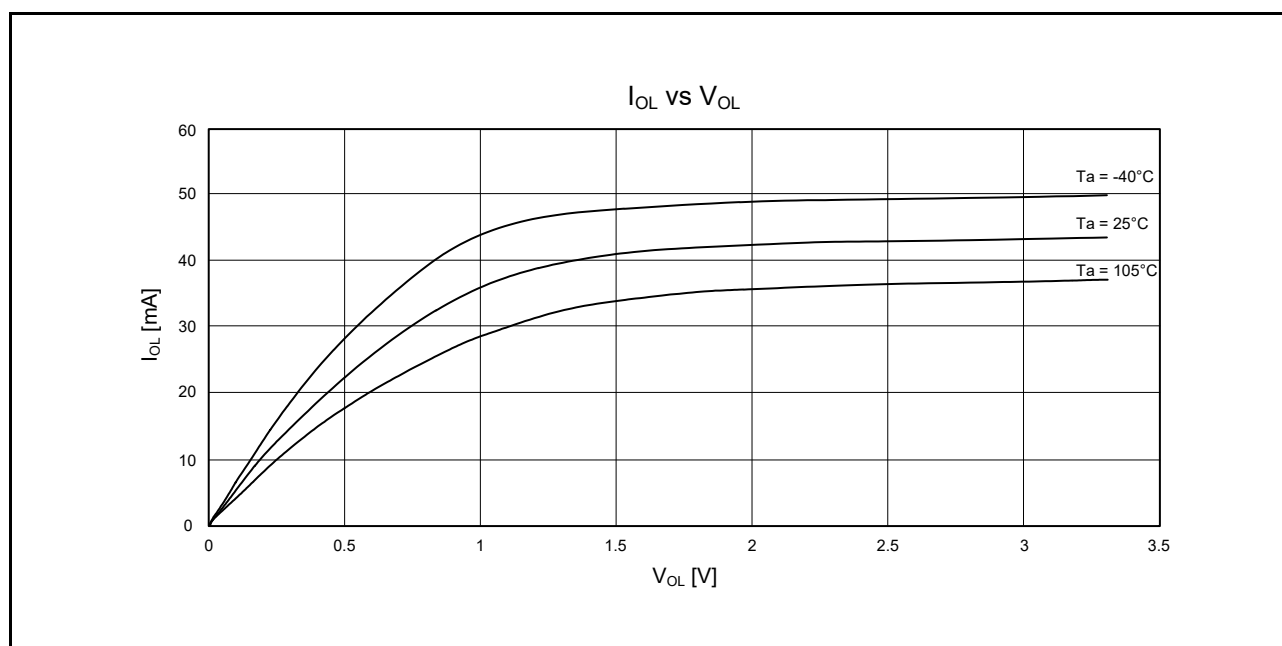


Figure 5.20 V_{OL} and I_{OL} Temperature Characteristics of RIIC Output Pin at $V_{CC} = 3.3\text{ V}$ (Reference Data)

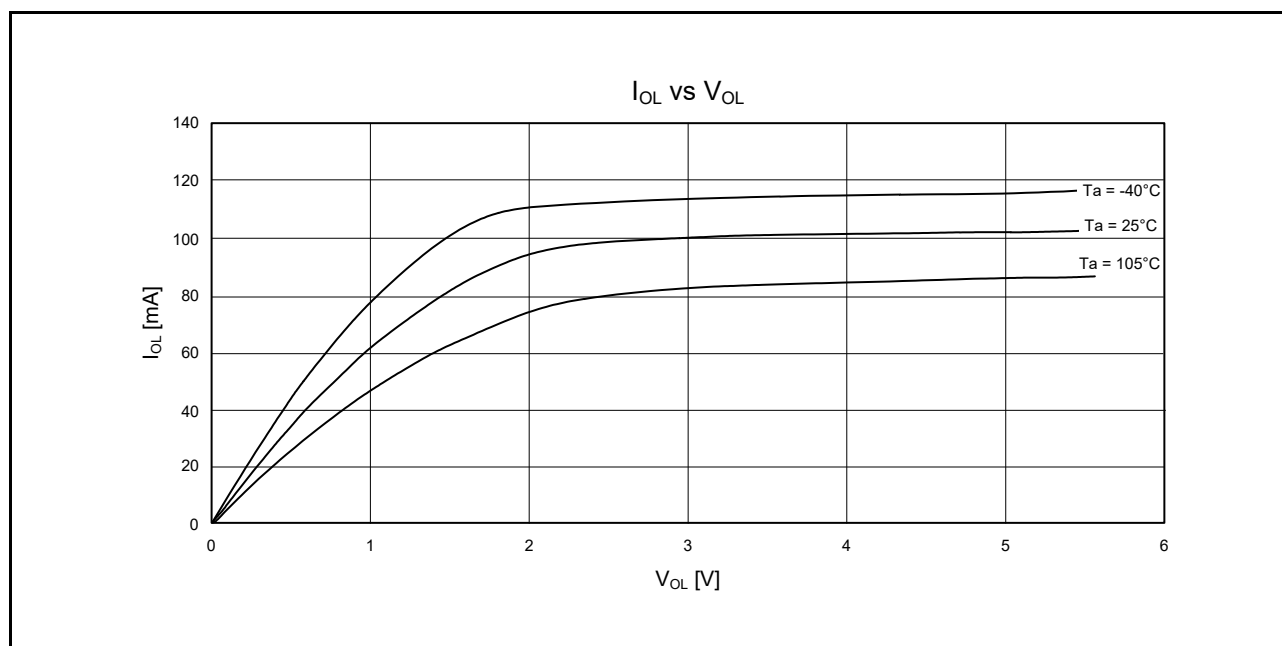


Figure 5.21 V_{OL} and I_{OL} Temperature Characteristics of RIIC Output Pin at $V_{CC} = 5.5\text{ V}$ (Reference Data)

5.3.2 Reset Timing

Table 5.27 Reset Timing

Conditions: $1.8\text{ V} \leq \text{VCC} = \text{VCC_USB} = \text{AVCC0} \leq 5.5\text{ V}$, $\text{VSS} = \text{AVSS0} = \text{VREFL0} = \text{VSS_USB} = 0\text{ V}$, $T_a = -40\text{ to }+105^\circ\text{C}$

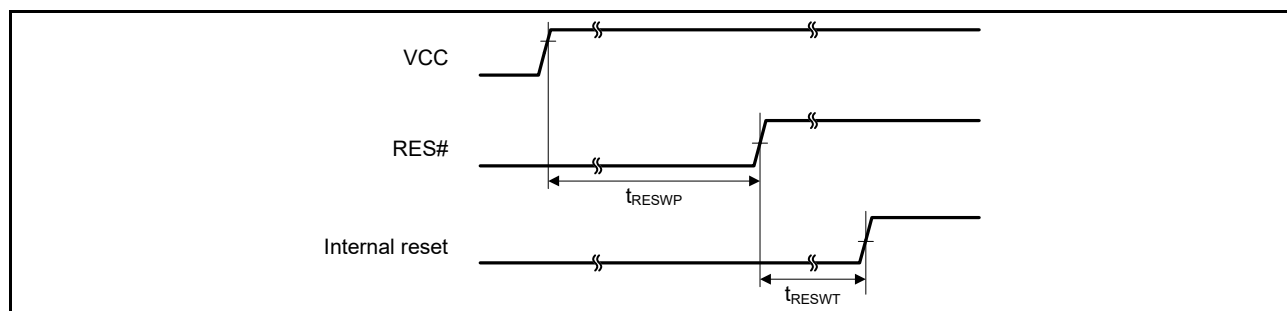
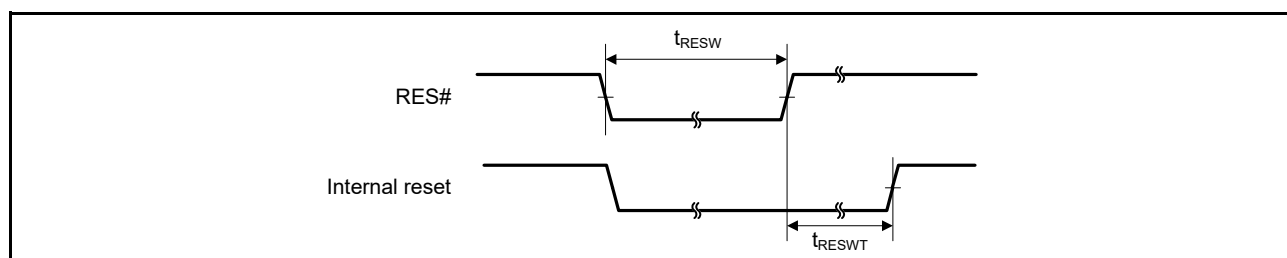
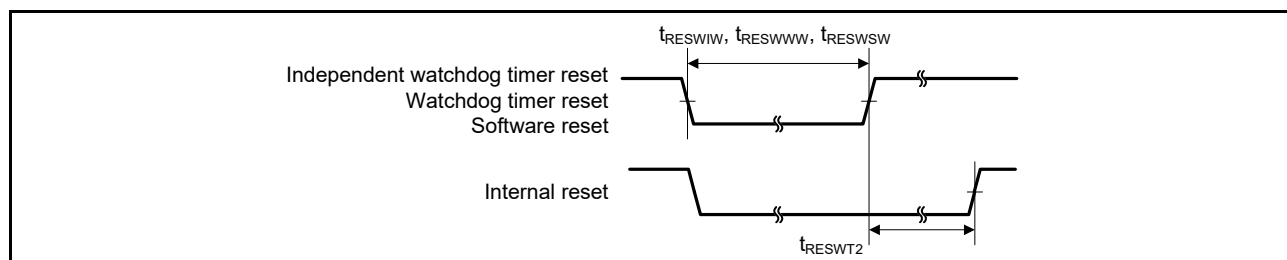
Item		Symbol	Min.	Typ.	Max.	Unit	Test Conditions
RES# pulse width	At power-on	t_{RESWP}	3	—	—	ms	Figure 5.31
	Other than above	t_{RESW}	30	—	—	μs	Figure 5.32
Wait time after RES# cancellation (at power-on)	At normal startup*1	t_{RESWT}	—	8.5	—	ms	Figure 5.31
	During fast startup time*2	t_{RESWT}	—	560	—	μs	
Wait time after RES# cancellation (during powered-on state)		t_{RESWT}	—	120	—	μs	Figure 5.32
Independent watchdog timer reset period		t_{RESWIW}	—	1	—	IWDTC clock cycle	Figure 5.33
Watchdog timer reset period		t_{RESWWW}	—	4	—	PCLKB cycle	
Software reset period		t_{RESWSW}	—	1	—	ICLK cycle	
Wait time after independent watchdog timer reset cancellation*3		t_{RESWT2}	—	300	—	μs	
Wait time after watchdog timer reset cancellation*4		t_{RESWT2}	—	300	—	μs	
Wait time after software reset cancellation		t_{RESWT2}	—	170	—	μs	

Note 1. When OFS1.(LVDAS, FASTSTUP) bits are 11b.

Note 2. When OFS1.(LVDAS, FASTSTUP) bits are a value other than 11b.

Note 3. When IWDTCR.CKS[3:0] bits are 0000b.

Note 4. When WDTTCR.CKS[3:0] bits are 0001b.

**Figure 5.31 Reset Input Timing at Power-On****Figure 5.32 Reset Input Timing (1)****Figure 5.33 Reset Input Timing (2)**

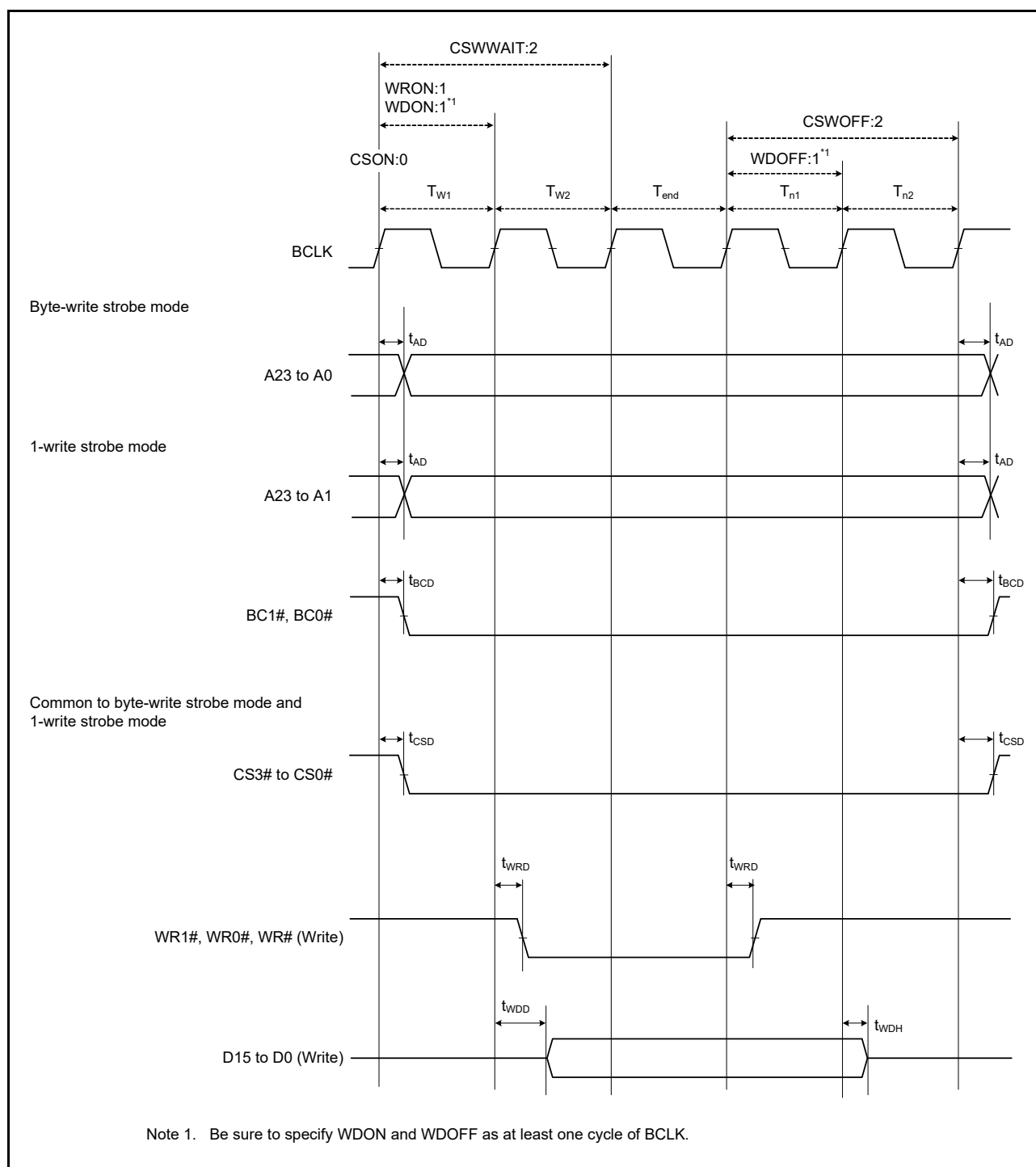


Figure 5.39 External Bus Timing/Normal Write Cycle (Bus Clock Synchronization)

Table 5.41 Timing of On-Chip Peripheral Modules (4)

Conditions: $2.7\text{ V} \leq V_{CC} = V_{CC_USB} = AV_{CC0} \leq 5.5\text{ V}$, $V_{SS} = AV_{SS0} = V_{SS_USB} = 0\text{ V}$, $f_{PCLKB} \leq 32\text{ MHz}$,
 $T_a = -40\text{ to }+105^\circ\text{C}$

Item		Symbol	Min.*1, *2	Max.	Unit	Test Conditions
RIIC (Standard mode, SMBus)	SCL cycle time	t _{SCL}	6 (12) × t _{IICcyc} + 1300	—	ns	Figure 5.59
	SCL high pulse width	t _{SCLH}	3 (6) × t _{IICcyc} + 300	—	ns	
	SCL low pulse width	t _{SCLL}	3 (6) × t _{IICcyc} + 300	—	ns	
	SCL, SDA rise time	t _{Sr}	—	1000	ns	
	SCL, SDA fall time	t _{Sf}	—	300	ns	
	SCL, SDA spike pulse removal time	t _{SP}	0	1 (4) × t _{IICcyc}	ns	
	SDA bus free time	t _{BUF}	3 (6) × t _{IICcyc} + 300	—	ns	
	START condition hold time	t _{STAH}	t _{IICcyc} + 300	—	ns	
	Repeated START condition setup time	t _{STAS}	1000	—	ns	
	STOP condition setup time	t _{STOS}	1000	—	ns	
	Data setup time	t _{SDAS}	t _{IICcyc} + 50	—	ns	
	Data hold time	t _{SDAH}	0	—	ns	
	SCL, SDA capacitive load	C _b	—	400	pF	
RIIC (Fast mode)	SCL cycle time	t _{SCL}	6 (12) × t _{IICcyc} + 600	—	ns	Figure 5.59
	SCL high pulse width	t _{SCLH}	3 (6) × t _{IICcyc} + 300	—	ns	
	SCL low pulse width	t _{SCLL}	3 (6) × t _{IICcyc} + 300	—	ns	
	SCL, SDA rise time	t _{Sr}	—	300	ns	
	SCL, SDA fall time	t _{Sf}	—	300	ns	
	SCL, SDA spike pulse removal time	t _{SP}	0	1 (4) × t _{IICcyc}	ns	
	SDA bus free time	t _{BUF}	3 (6) × t _{IICcyc} + 300	—	ns	
	START condition hold time	t _{STAH}	t _{IICcyc} + 300	—	ns	
	Repeated START condition setup time	t _{STAS}	300	—	ns	
	STOP condition setup time	t _{STOS}	300	—	ns	
	Data setup time	t _{SDAS}	t _{IICcyc} + 50	—	ns	
	Data hold time	t _{SDAH}	0	—	ns	
	SCL, SDA capacitive load	C _b	—	400	pF	

Note: t_{IICcyc} : RIIC internal reference clock (IICφ) cycle

Note 1. The value in parentheses is used when the ICMR3.NF[1:0] bits are set to 11b while a digital filter is enabled with the ICFER.NFE bit = 1.

Note 2. C_b is the total capacitance of the bus lines.

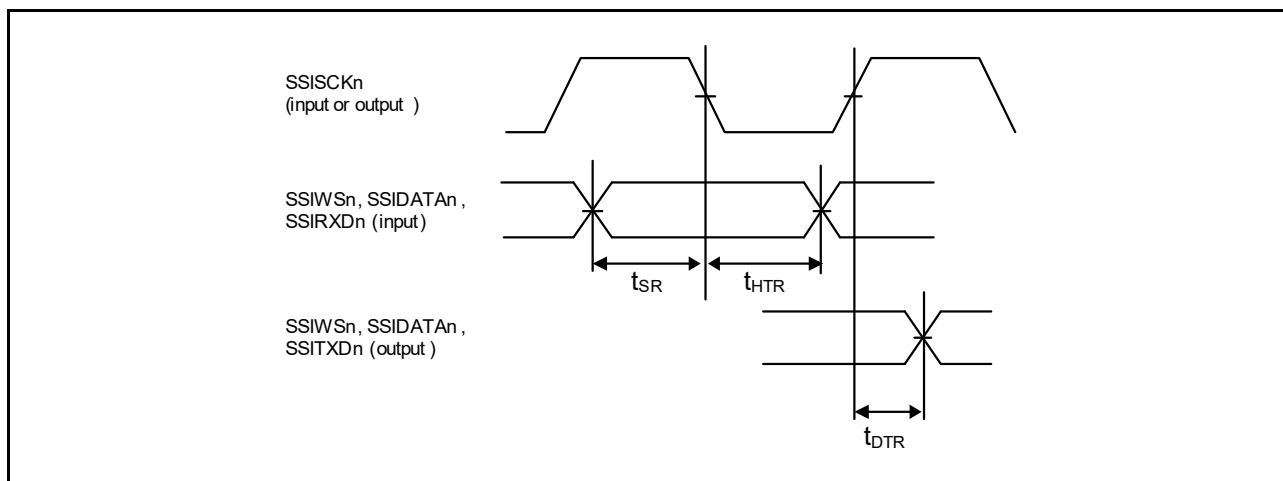


Figure 5.62 SSI Transmission/Reception Timing (SSICR.SCKP=1)

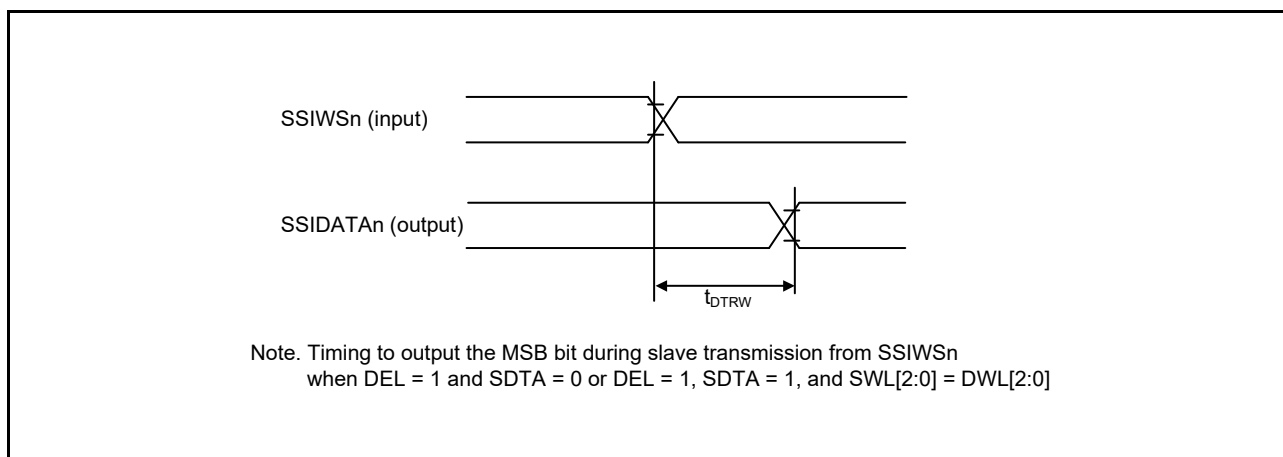


Figure 5.63 SSIDATA Output Delay After SSIWSn Changing Edge

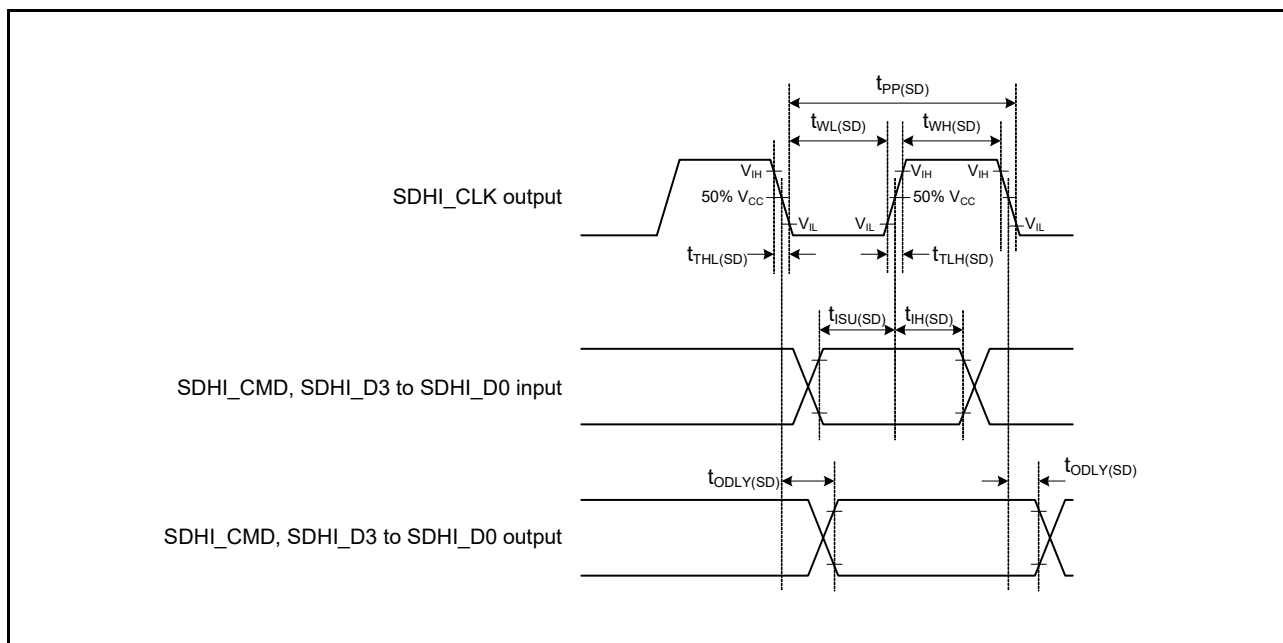


Figure 5.64 SD Host Interface Input/Output Signal Timing

5.5 A/D Conversion Characteristics

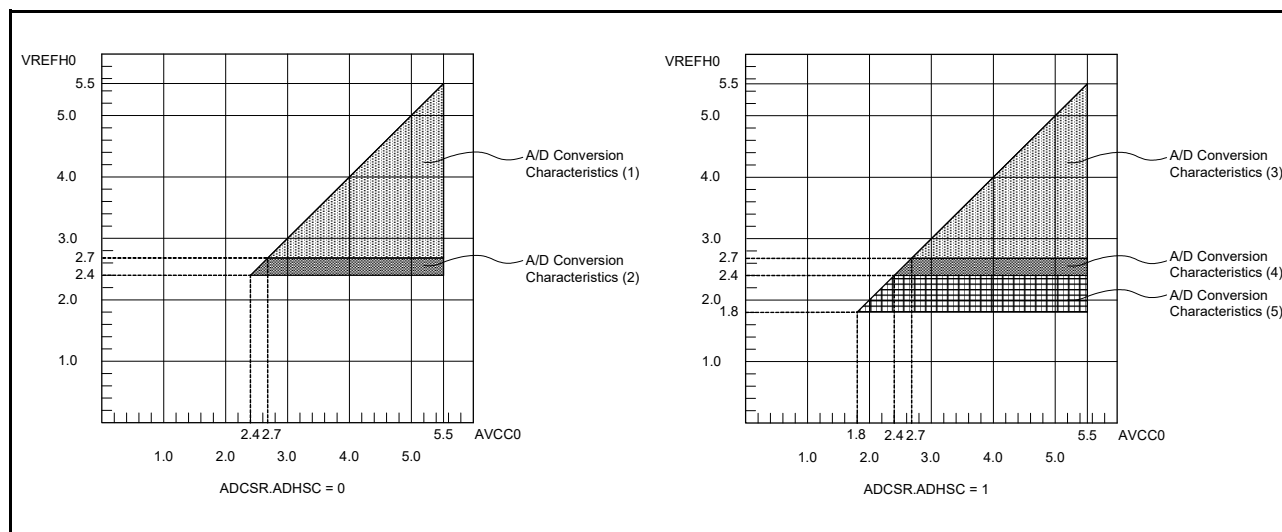


Figure 5.67 VREFH0 Voltage Range vs. AVCC0

Table 5.46 A/D Conversion Characteristics (1)

Conditions: $2.7\text{ V} \leq VCC = VCC_USB = AVCC0 \leq 5.5\text{ V}$, $2.7\text{ V} \leq VREFH0 \leq AVCC0$, reference voltage = VREFH0 selected, $VSS = AVSS0 = VREFL0 = VSS_USB = 0\text{ V}$, $T_a = -40\text{ to }+105^\circ\text{C}$

Item		Min.	Typ.	Max.	Unit	Test Conditions
Frequency		1	—	54	MHz	
Resolution		—	—	12	Bit	
Conversion time*1 (Operation at PCLKD = 54 MHz)	Permissible signal source impedance (Max.) = 0.3 kΩ	0.83	—	—	μs	High-precision channel The ADCSR.ADHSC bit is 0 The ADSSTRn register is 0Dh
		1.33	—	—		Normal-precision channel The ADCSR.ADHSC bit is 0 The ADSSTRn register is 28h
Analog input capacitance	Cs	—	—	15	pF	Pin capacitance included Figure 5.68
Analog input resistance	Rs	—	—	2.5	kΩ	Figure 5.68
Analog input voltage range	Ain	0	—	VREFH0	V	
Offset error		—	±0.5	±4.5	LSB	High-precision channel
				±6.0	LSB	Other than above
Full-scale error		—	±0.75	±4.5	LSB	High-precision channel
				±6.0	LSB	Other than above
Quantization error		—	± 0.5	—	LSB	
Absolute accuracy		—	± 1.25	±5.0	LSB	High-precision channel
				±8.0	LSB	Other than above
DNL differential non-linearity error		—	±1.0	—	LSB	
INL integral non-linearity error		—	±1.0	±3.0	LSB	

Note: The characteristics apply when no pin functions other than A/D converter input are used. Absolute accuracy includes quantization errors. Offset error, full-scale error, DNL differential non-linearity error, and INL integral non-linearity error do not include quantization errors.

Note 1. The conversion time is the sum of the sampling time and the comparison time. As the test conditions, the number of sampling states is indicated.

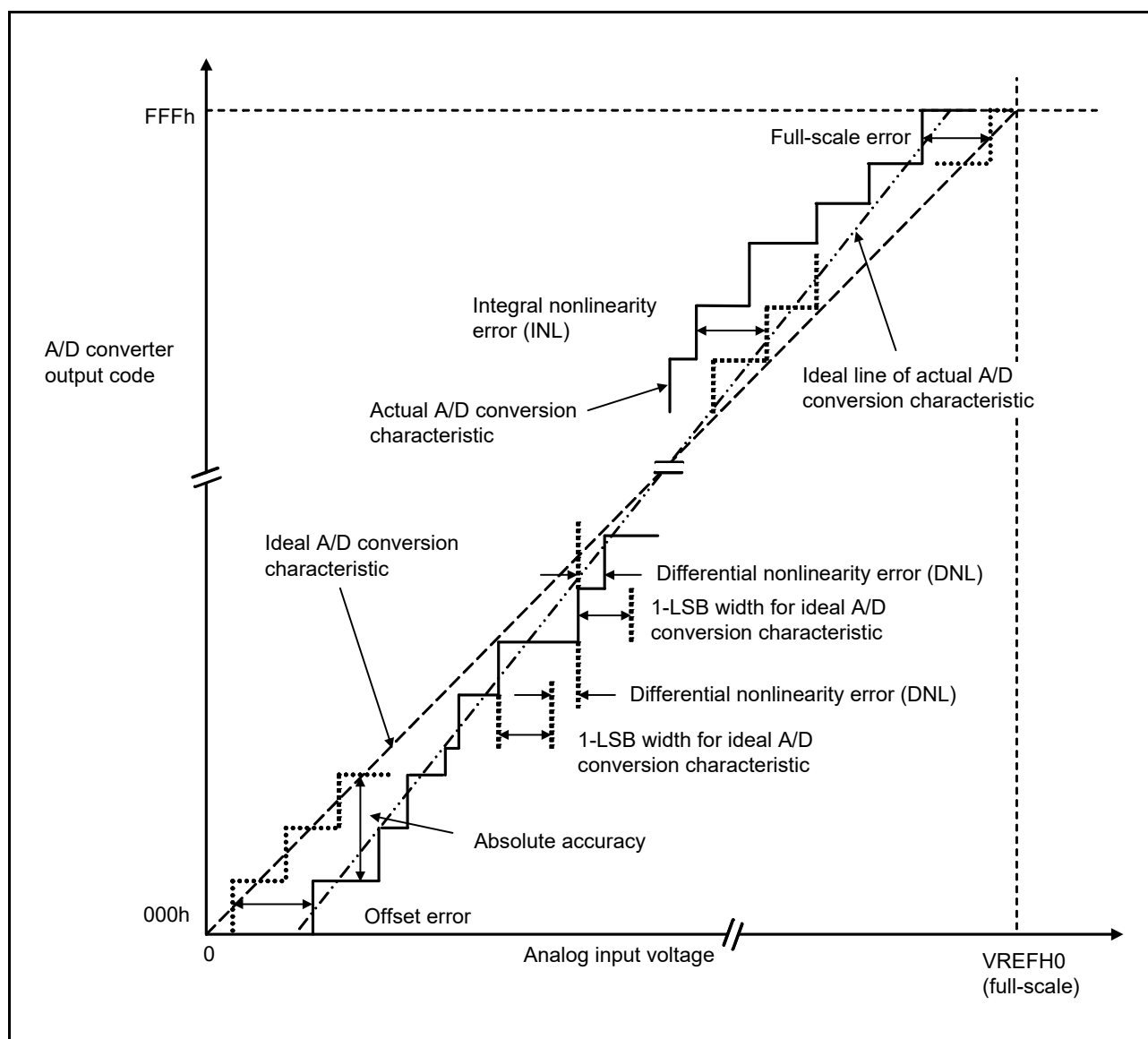


Figure 5.69 Illustration of A/D Converter Characteristic Terms

Absolute accuracy

Absolute accuracy is the difference between output code based on the theoretical A/D conversion characteristics and the actual A/D conversion result. When measuring absolute accuracy, the voltage at the midpoint of the width of analog input voltage (1-LSB width), that can meet the expectation of outputting an equal code based on the theoretical A/D conversion characteristics, is used as an analog input voltage. For example, if 12-bit resolution is used and if reference voltage ($V_{REFH0} = 3.072\text{ V}$), then 1-LSB width becomes 0.75 mV, and 0 mV, 0.75 mV, 1.5 mV, ... are used as analog input voltages.

If analog input voltage is 6 mV, absolute accuracy = $\pm 5\text{ LSB}$ means that the actual A/D conversion result is in the range of 003h to 00Dh, although an output code, 008h, can be expected from the theoretical A/D conversion characteristics.

Integral non-linearity error (INL)

The integral non-linearity error is the maximum deviation between the ideal line when the measured offset and full-scale errors are zeroed, and the actual output code.

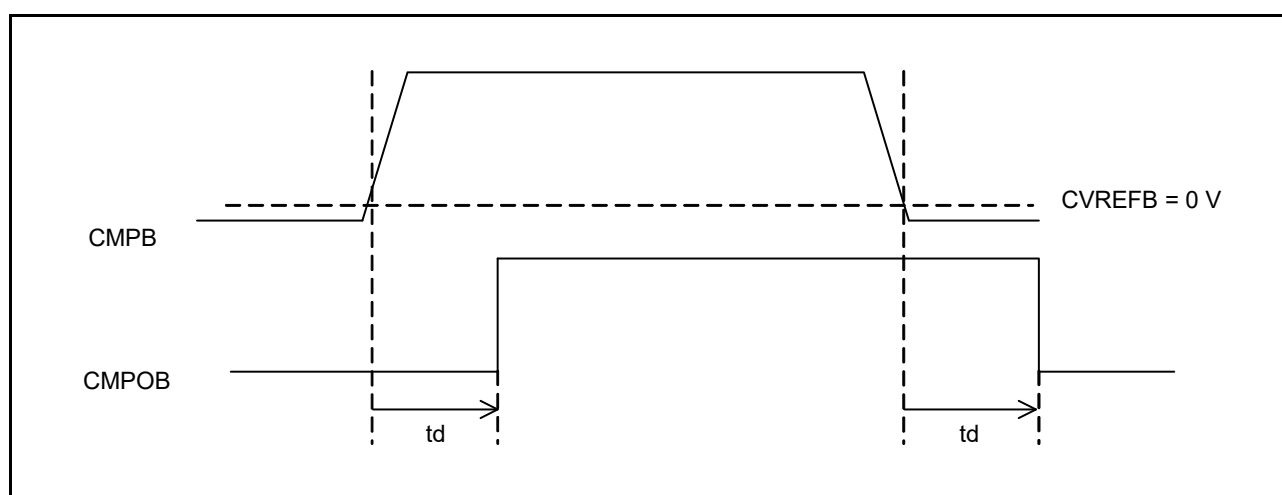


Figure 5.71 Comparator Output Delay Time in Comparator High-Speed Mode and Low-Speed Mode

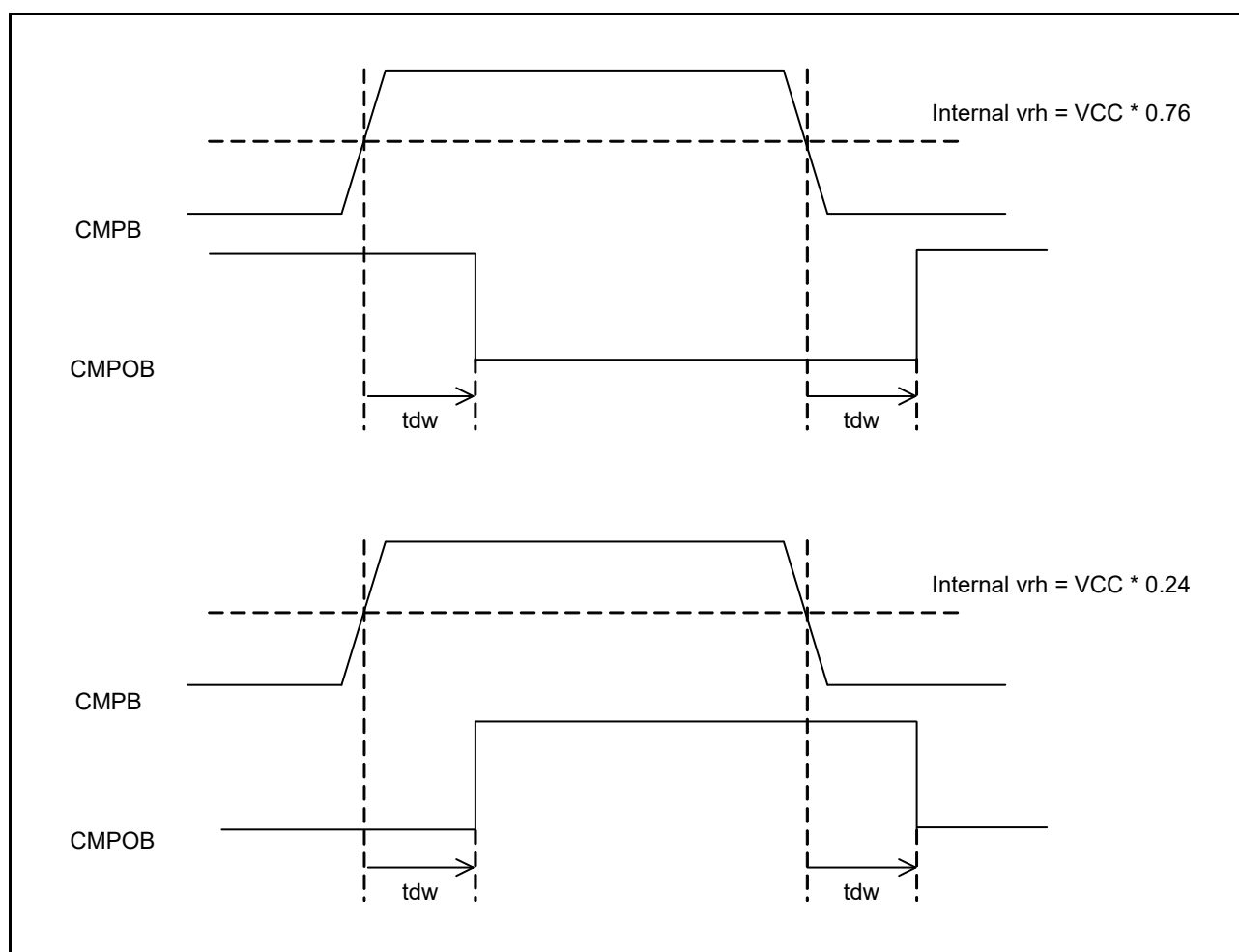


Figure 5.72 Comparator Output Delay Time in High-Speed Mode with Window Function Enabled

5.13 ROM (Flash Memory for Code Storage) Characteristics

Table 5.62 ROM (Flash Memory for Code Storage) Characteristics (1)

Item	Symbol	Min.	Typ.	Max.	Unit	Conditions
Reprogramming/erasure cycle*1	N _{PEC}	1000	—	—	Times	
Data hold time	After 1000 times of N _{PEC} t _{DRP}	20*2, *3	—	—	Year	T _a = +85°C

Note 1. Definition of reprogram/erase cycle: The reprogram/erase cycle is the number of erasing for each block. When the reprogram/erase cycle is n times (n = 1000), erasing can be performed n times for each block. For instance, when 4-byte programming is performed 256 times for different addresses in a 1-Kbyte block and then the entire block is erased, the reprogram/erase cycle is counted as one. However, programming the same address for several times as one erasing is not enabled (overwriting is prohibited).

Note 2. Characteristic when using the flash memory programmer and the self-programming library provided from Renesas Electronics.

Note 3. This result is obtained from reliability testing.

Table 5.63 ROM (Flash Memory for Code Storage) Characteristics (2) High-Speed Operating Mode

Conditions: 2.7 V ≤ VCC = VCC_USB = AVCC0 ≤ 5.5 V, VSS = AVSS0 = VSS_USB = 0 V

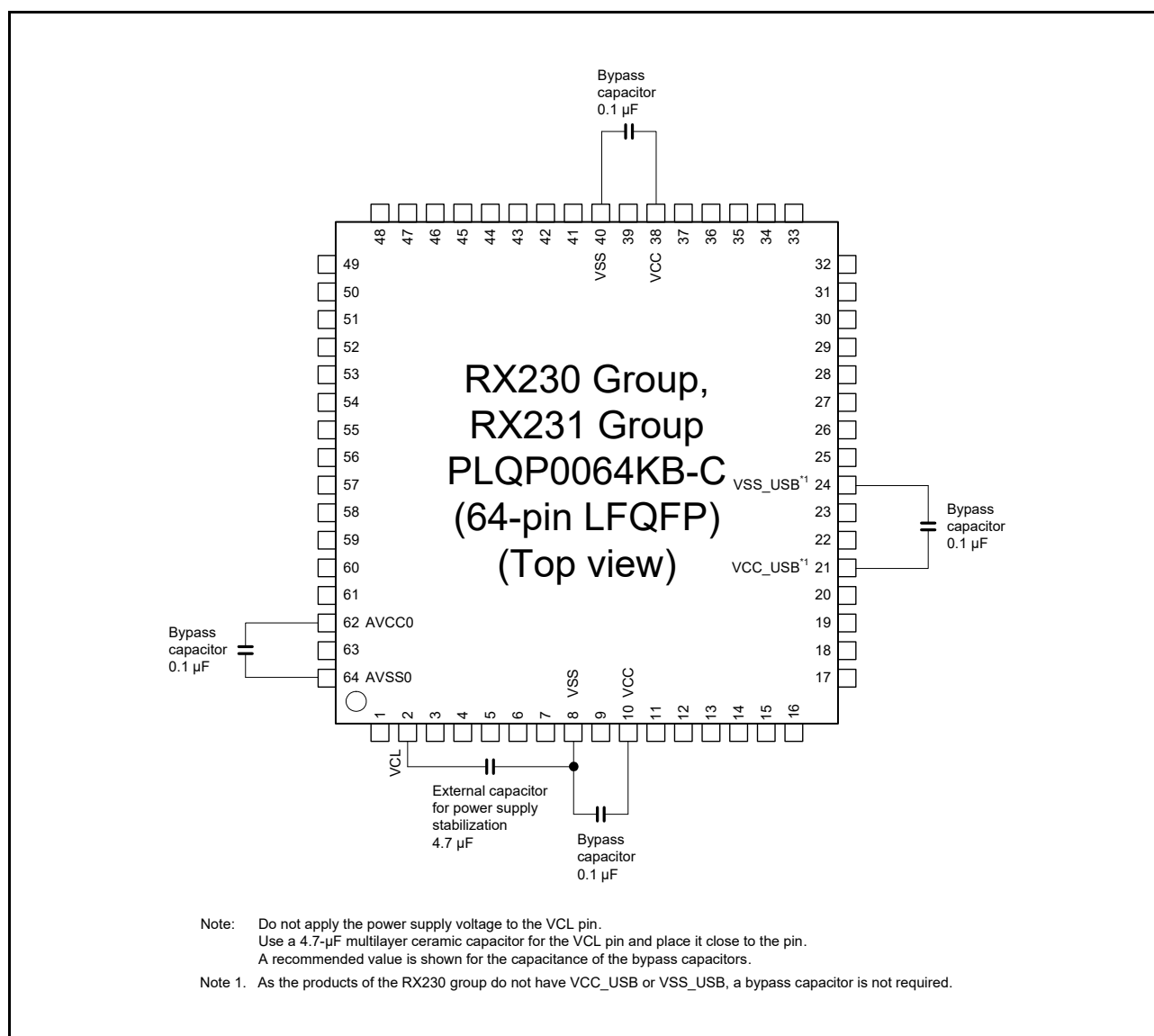
Temperature range for the programming/erasure operation: T_a = −40 to +105°C

Item		Symbol	FCLK = 1 MHz			FCLK = 32 MHz			Unit
			Min.	Typ.	Max.	Min.	Typ.	Max.	
Programming time	8-byte	t _{P8}	—	112	967	—	52.3	491	μs
Erasure time	2-Kbyte	t _{E2K}	—	8.75	278	—	5.50	215	ms
	512-Kbyte (when block erase command is used)	t _{E512K}	—	928	19218	—	72.0	1679	ms
	512-Kbyte (when all-block erase command is used)	t _{EA512K}	—	923	19013	—	66.7	1469	ms
Blank check time	8-byte	t _{BC8}	—	—	55.0	—	—	16.1	μs
	2-Kbyte	t _{BC2K}	—	—	1840	—	—	136	ms
Erasure operation forced stop time		t _{SED}	—	—	18.0	—	—	10.7	μs
Start-up area switching setting time		t _{SAS}	—	12.3	566.5	—	6.2	434	ms
Access window time		t _{AWS}	—	12.3	566.5	—	6.2	434	ms
ROM mode transition wait time 1		t _{DIS}	2.0	—	—	2.0	—	—	μs
ROM mode transition wait time 2		t _{MS}	5.0	—	—	5.0	—	—	μs

Note: The time until each operation of the flash memory is started after instructions are executed by software is not included.

Note: The lower-limit frequency of FCLK is 1 MHz during programming or erasing of the flash memory. When using FCLK at below 4 MHz, the frequency can be set to 1 MHz, 2 MHz, or 3 MHz. A non-integer frequency such as 1.5 MHz cannot be set.

Note: The frequency accuracy of FCLK must be within ±3.5%.

**Figure 5.81 Connecting Capacitors (64 Pins)**

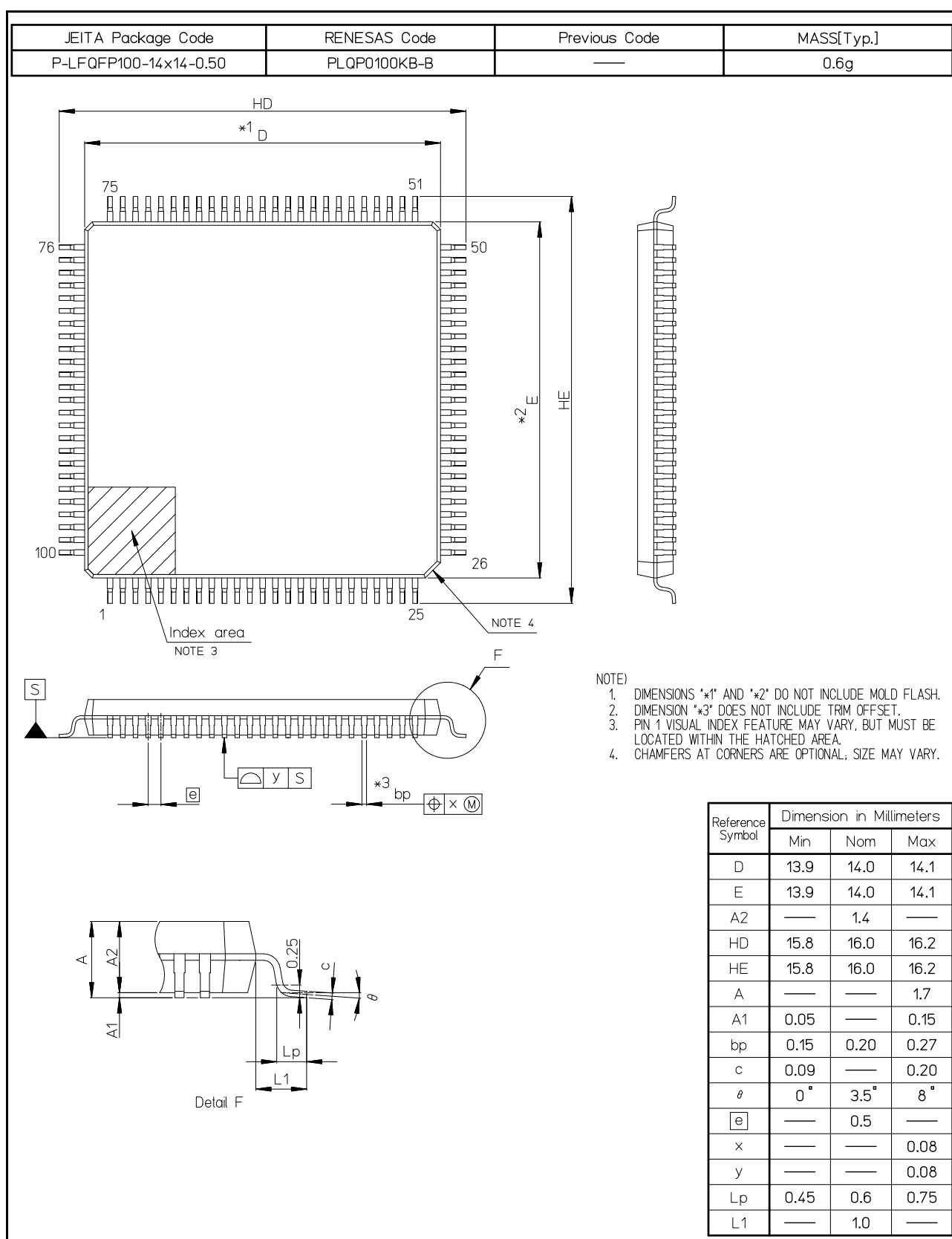


Figure B 100 -Pin LFQFP (PLQP0100KB-B)

JEITA Package code	RENESAS code	Previous code	MASS(TYP.)[g]
P-HWQFN48-7x7-0.50	PWQN0048KB-A	48PJN-A P48K8-50-5B4-7	0.13

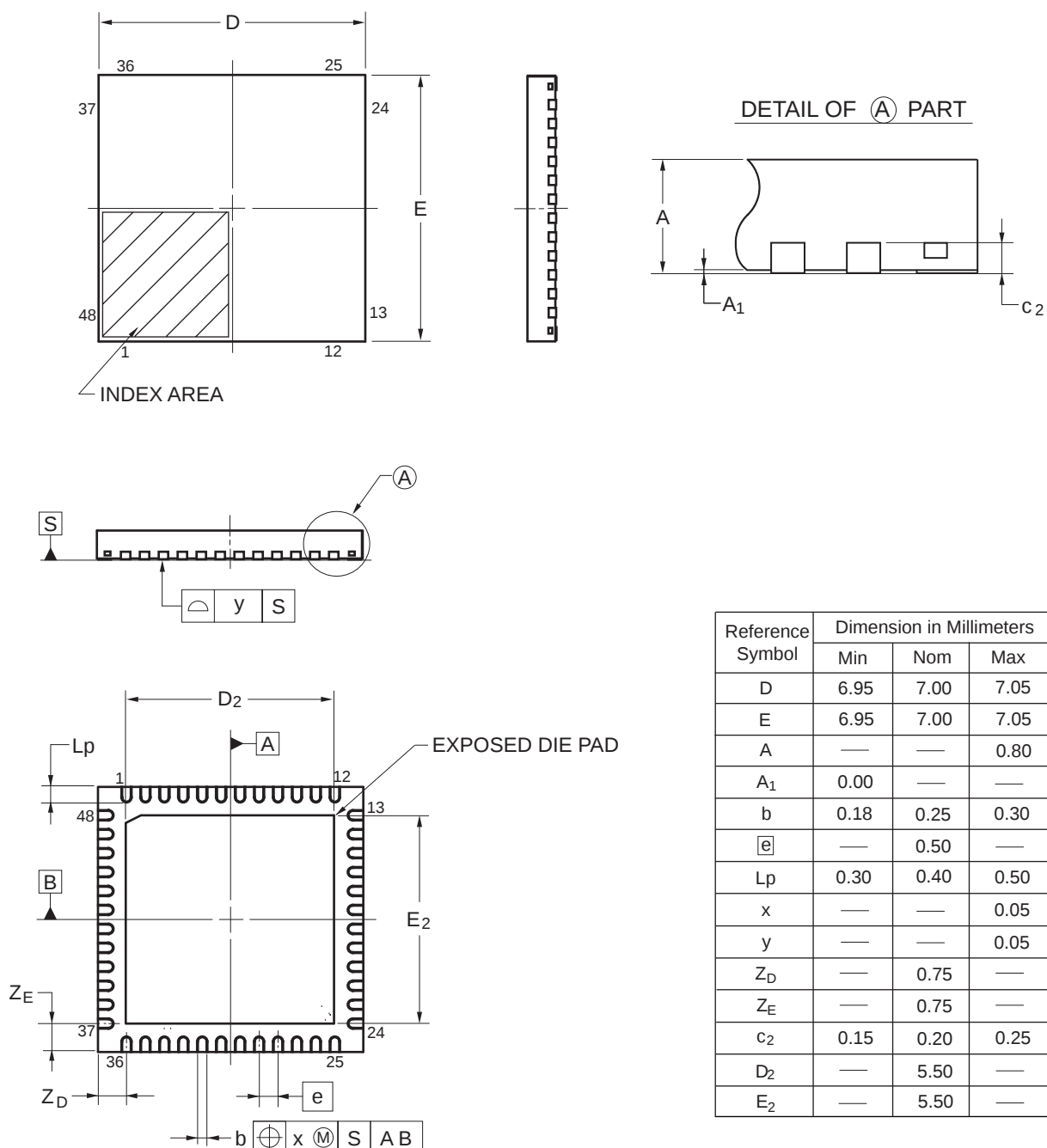


Figure F 48 -Pin HWQFN (PWQN0048KB-A)

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